uClamp5612T Ultra Small µClamp[®] ESD Protection for Battery Interfaces

PROTECTION PRODUCTS - MicroClamp[®] Description

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 μ Clamp[®] TVS diodes are designed to protect sensitive electronics from damage or latch-up due to ESD. They are designed to replace multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and other portable electronics. They feature large cross-sectional area junctions for conducting high transient currents. This device offers desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

The μ Clamp[®]5612T is in a 5-pin SLP1508N5T package. It measures 1.5 x 0.8 x 0.40mm. The leads are spaced at a pitch of 0.35mm and are finished with lead-free NiPdAu. Each device will protect one line operating at 12 volts and two lines operating at 5 volts. They may be used to meet the ESD immunity requirements of IEC 61000-4-2. The combination of small size and high ESD surge capability, and dual operating voltage makes them ideal for protecting battery interfaces in cellular phones.

Features

- High ESD withstand Voltage: ±30kV (air), ±30kV (contact) per IEC 61000-4-2
- Small package saves board space
- Protects two battery sensor pins to 5V
- Protects battery voltage bus operating up to 12V
- Low reverse current
- Innovative flow-through design allows easy pcb layout
- Solid-state silicon-avalanche technology

Mechanical Characteristics

- SLP1508N5T 5L package
- Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Nominal Dimensions: 1.5 x 0.8 x 0.40 mm
- Lead Finish: NiPdAu
- Molding compound flammability rating: UL 94V-0
- Marking : Marking code + date code
- Packaging : Tape and Reel

Applications

- Cellular Handsets
- Battery Interfaces





PIN Configuration



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Absolute Maximum Rating						
Rating	Symbol	Value	Units			
Batt_Therm, Batt_ID		•				
Peak Pulse Power (tp = $8/20\mu s$)	P _{pk}	125	Watts			
Peak Pulse Current (tp = 8/20µs)	I _{PP}	10	A			
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{esd}	±30 ±30	kV			
Operating Temperature	T,	-55 to +125	°C			
Storage Temperature	T _{stg}	-55 to +150	°C			
VBatt	•	-	-			
Peak Pulse Power (tp = $8/20\mu s$)	P _{pk}	300	Watts			
Peak Pulse Current (tp = 8/20µs)	I _{PP}	10	A			
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	±30 ±30	kV			

T,

 $\mathsf{T}_{_{\mathsf{STG}}}$

-55 to +125

-55 to +150

Operating Temperature

Storage Temperature

°C

°C

uClamp5612T

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Electrical Characteristics (T=25°C)

Batt_Therm, Batt_ID

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V _{RWM}	Pin 3, or 4 to GND			5	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA Pin 3, or 4 to GND	6.5	7.5	11	V
Reverse Leakage Current	I _R	V _{RWM} = 5V, T=25°C Pin 3, or 4 to GND		0.050	0.500	μA
Clamping Voltage	V _c	I _{PP} = 1A, t _p = 8/20µs Pin 3, or 4 to GND			10	V
Clamping Voltage	V _c	I _{pp} = 10A, t _p = 8/20μs Pin 3, or 4 to GND			12.5	V
Junction Capacitance	C _j	V _R = 0V, f = 1MHz Pin 3, or 4 to GND		90	115	pF
VBatt						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V _{RWM}	Pin 1 to GND			12	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA, Pin 1 to GND	15	16.5	18	V
Reverse Leakage Current	I _R	V _{RWM} = 12V Pin 1 to GND		0.005	0.100	μA
Forward Voltage	V _F	I _r = 10mA GND to Pin 1	0.6		1.0	V
Clamping Voltage	V _c	I _{pp} = 10A, tp = 8/20µs Pin 1 to Ground			30	V
Forward Clamping Voltage	V _{FC}	I _{pp} = 10A, tp = 8/20µs Ground to Pin 1			3	V
Junction Capacitance	C _j	V _R = OV, f = 1MHz Pin 1 to GND		50	75	pF



Typical Characteristics



Non-Repetitive Peak Pulse Power vs. Pulse Time (Batt_Therm, Batt_ID) 1 0.1











Junction Capacitance vs. Reverse Voltage



Breakdown Voltage (VBR) vs. Temperature





Typical Characteristics

TLP Characteristic (Positive)











TLP Characteristic (Negative)



ESD Clamping (-8kV Contact per IEC 61000-4-2) VBatt Pin (Pin 1)



ESD Clamping -8kV Contact per IEC 61000-4-2) Batt_Therm, Batt_ID Pins (Pins 3, 4)







Typical Characteristics

Typical Insertion Loss S21 VBus Pin (Pin 1)







Applications Information

Device Connection Options

The μ Clamp5612T is designed to protect two data lines operating up to 5 volts and one voltage supply line operating up to 12 volts. It is specifically designed for protection of battery interfaces in mobile phones. The 12 volt TVS is located at pin 1. The 5 volt TVS diodes are located at pins 3 and 4. Pin 2 is not internally connected. Ground is provided at pin 5. Multiple micro vias connected to ground are recommended for best ESD performance. This will reduce parasitic inductance in the ground path and minimize the clamping voltage seen by the protected device.



Pin Configuration



PCB Layout Example

uClamp5612T



PROTECTION PRODUCTS

Applications Information

Assembly Guidelines

The small size of this device means that some care must be taken during the mounting process to insure reliable solder joint. The table below provides Semtech's recommended assembly guidelines for mounting this device. The figure at the right details Semtech's recommended aperture based on the below recommendations. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. The exact manufacturing parameters will require some experimentation to get the desired solder application.

Assembly Parameter	Recommendation		
Solder Stencil Design	Laser cut, Electro-polished		
Aperture shape	Rectangular		
Solder Stencil Thickness	0.100 mm (0.004")		
Solder Paste Type	Type 4 size sphere or smaller		
Solder Reflow Profile	Per JEDEC J-STD-020		
PCB Solder Pad Design	Non-Solder mask defined		
PCB Pad Finish	OSP OR NiAu		



Recommended Mounting Pattern



uClamp5612T

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Outline Drawing - SLP1508N5T



Land Pattern - SLP1508N5T





Marking Code



Notes:

Marking will also include line matrix date code

Carrier Tape Specification

Ordering Information

Part Number	Qty per Reel	Reel Size	
uClamp5612T.TNT	10,000	7 Inch	

Notes:

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SECTION A-A

Device Orientation in Tape



Pin 1 Location (Towards Sprocket Holes)

Contact Information

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